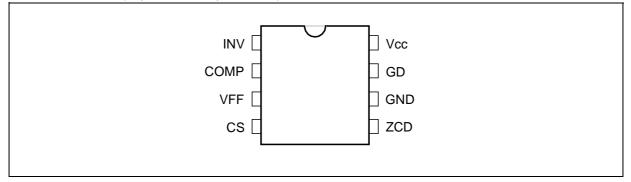
## **DESCRIPTION** (continued)

Converter's power capability variations with the mains voltage are compensated by line voltage feedforward. At light load the device features a special function that automatically lowers the operating frequency still maintaining the operation as close to ZVS as possible. In addition to very low start-up and quiescent currents, this feature helps keep low the consumption from the mains at light load and be Blue Angel and Energy Star compliant.

The IC includes also a disable function, an on-chip filter on current sense, an error amplifier with a precise reference voltage for primary regulation and an effective two-level overcurrent protection.

## **PIN CONNECTION** (Top view, Minidip and SO8)



# PIN DESCRIPTION

N°	Name	Function
1	INV	Inverting input of the error amplifier. The information on the output voltage is fed into the pin through either a resistor divider (primary regulation) or an optocoupler (secondary feedback). This pin can be grounded in some secondary feedback schemes (see pin 2).
2	COMP	Output of the error amplifier. Typically, a compensation network is placed between this pin and the INV pin to achieve stability and good dynamic performance of the voltage control loop. With secondary feedback, the pin can be also driven directly by an optocoupler to control PWM by modulating the current sunk from the pin (with the INV pin grounded).
3	VFF	Line voltage feedforward. The information on the converter's input voltage is fed into the pin through a resistor divider and is used to change the setpoint of the pulse-by-pulse current limitation (the higher the voltage, the lower the setpoint). If this function is not desired the pin will be grounded and the current limitation setpoint will be maximum.
4	CS	Input to the PWM comparator. The primary current is sensed through a resistor, the resulting voltage is applied to this pin and compared with an internal reference to determine MOSFET's turn-off. The internal reference is clamped at a value, which defines the pulse-by-pulse current limitation setpoint, depending on the voltage at pin VFF. If the signal at the pin CS exceeds 2 V, the gate driver will be disabled (Hiccup-mode OCP).
5	ZCD	Transformer's demagnetization sensing input for Quasi-Resonant operation. Alternately, synchronization input for an external signal. A negative-going edge triggers MOSFET's turn-on. The trigger circuit is blanked for a minimum of 3.5 µs after MOSFET turn-off, for safe operation under short circuit conditions and frequency foldback. If the pin is grounded the IC will be disabled.
6	GND	Ground. Current return for both the signal part of the IC and the gate driver.
7	GD	Gate driver output. The totem pole output stage is able to drive power MOSFET's and IGBT's with a peak current of 400 mA (source and sink).
8	Vcc	Supply Voltage of both the signal part of the IC and the gate driver. An electrolytic capacitor is connected between this pin and ground. A resistor connected from this pin to the converter's input bulk capacitor will be typically used to start up the device.

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## THERMAL DATA

Symbol	Parameter	SO8	Minidip	Unit
R <sub>th</sub> j-amb	Max. Thermal Resistance, Junction-to-ambient	150	100	°C/W

#### **ABSOLUTE MAXIMUM RATINGS**

Symbol	Pin	Parameter	Value	Unit
I <sub>Vcc</sub>	8	I <sub>CC</sub> + I <sub>Z</sub>	30	mA
I <sub>GD</sub>	7	Output Totem Pole Peak Current (2 µs)	±700	mA
INV, COMP, VFF, CS	1, 2, 3 4	Analog Inputs & Outputs	-0.3 to 7	V
IZCD	5	Zero Current Detector	50 (source) -10 (sink)	mA
P <sub>tot</sub>		Power Dissipation @Tamb = 50°C(Minidip)(SO8)	1 0.65	W
Тј		Junction Temperature Operating range	-40 to 150	°C
T <sub>stg</sub>		Storage Temperature	-55 to 150	°C

## **ELECTRICAL CHARACTERISTCS**

(T<sub>j</sub> = -25 to 125°C, V<sub>CC</sub> = 12V, C<sub>o</sub> = 1nF; unless otherwise specified)

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Unit
SUPPLY	VOLTAGE	<b>I</b>	l			
V <sub>cc</sub>	Operating range	After turn-on	10.3		18	
V <sub>CCOn</sub>	Turn-on threshold		12.5	13.5	14.5	V
Vccoff	Turn-off threshold		8.7	9.5	10.3	V
Hys	Hysteresis		3.65	4	4.3	V
Vz	Zener Voltage	I <sub>cc</sub> = 25 mA	18	20	22	V
SUPPLY	CURRENT	· · ·	•	•		
I <sub>start-up</sub>	Start-up Current	Before turn-on, $V_{CC} = 12V$		45	70	μA
Ιq	Quiescent Current	After turn-on		2.3	3.5	mA
Icc	Operating Supply Current	@ 70 kHz		3.5	5	mA
lq	Quiescent Current	During Hiccup-mode OCP	1.6		3.5	mA
Ιq	Quiescent Current	V <sub>ZCD</sub> < V <sub>DIS</sub> , V <sub>CC</sub> >V <sub>CCOff</sub>		1.4	2.1	mA
LINE FEE	DFORWARD			•		
I <sub>VFF</sub>	Input Bias Current	V <sub>VFF</sub> = 0 to 3 V			-1	μA
VVFF	Operating Range			0 to 3		V
K	Gain	V <sub>VFF</sub> = 1.5V, V <sub>COMP</sub> = 4V		0.16		
ERROR A	AMPLIFIER					
VINV	Voltage Feedback Input	T <sub>amb</sub> = 25°C	2.465	2.5	2.535	V
	Threshold	12V < V <sub>CC</sub> < 18V	2.44		2.56	
	Line Regulation	Vcc = 12 to 18V		2	5	mV
I <sub>INV</sub>	Input Bias Current			-0.1	-1	μA

<b>-</b> 7 <b>-</b> 7	

# ELECTRICAL CHARACTERISTCS (continued)

(T<sub>j</sub> = -25 to 125°C,  $V_{CC}$  = 12V,  $C_o$  = 1nF; unless otherwise specified)

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Unit
Gv	Voltage Gain	Open loop	60	80		dB
GB	Gain-Bandwidth Product			1		MHz
I <sub>COMP</sub>	Source Current	$V_{COMP} = 4V, V_{INV} = 2.4 V$	-2	-3.5	-5	mA
	Sink Current	VCOMP = 4V, VINV = 2.6 V	2.5	4.5		mA
V <sub>COMP</sub>	Upper Clamp Voltage	ISOURCE = 0.5 mA	5	5.5		V
	Lower Clamp Voltage	ISINK = 0.5 mA		2.25	2.55	V
CURREN	T SENSE COMPARATOR	1	1			
I <sub>CS</sub>	Input Bias Current	V <sub>CS</sub> = 0	1	-0.05	-1	μA
t <sub>d(H-L)</sub>	Delay to Output			200	450	ns
V <sub>CSx</sub>	Current Sense Reference Clamp	$V_{COMP} = Upper clamp, V_{VFF} = 0V$	1.28	1.4	1.5	V
		V <sub>COMP</sub> = Upper clamp, V <sub>VFF</sub> = 1.5V	0.62	0.7	0.78	
		$V_{COMP}$ = Upper clamp, $V_{VFF}$ = 3V		0	0.2	
VCSdis	Hiccup-mode OCP level		1.85	2.0	2.2	V
ZERO CU	<b>RRENT DETECTOR/ SYNCHRON</b>	IZATION	1			
VZCDH	Upper Clamp Voltage	I <sub>ZCD</sub> = 3mA	4.7	5.2	6.1	V
VZCDL	Lower Clamp Voltage	I <sub>ZCD</sub> = - 3mA	0.3	0.65	1	V
V <sub>ZCDA</sub>	Arming Voltage (positive-going edge)	(1)		2.1		V
VZCDT	Triggering Voltage (negative-going edge)			1.6		V
IZCDb	Input Bias Current	V <sub>ZCD</sub> = 1 to 4.5 V		2		μA
IZCDsrc	Source Current Capability		-3		-10	mA
I <sub>ZCDsnk</sub>	Sink Current Capability		3		10	mA
VDIS	Disable Threshold		150	200	250	mV
I <sub>ZCDr</sub>	Restart Current After Disable	V <sub>ZCD</sub> < V <sub>DIS</sub> , Vcc > Vcc <sub>off</sub>	-70	-150	-230	μA
TBLANK	Blanking time after pin 7 high-to-	VCOMP ≥ 3.2 V		3.5		μs
	low transition	V <sub>COMP</sub> = 2.5 V		18		
START TI	MER					
<b>t</b> START	Start Timer period		250	400	550	μs
GATE DR	IVER		•	•	•	
Vol	Dropout Voltage	I <sub>GDsource</sub> = 200mA		1.2	2	V
		I <sub>GDsource</sub> = 20mA		0.7	1	
Voh		I <sub>GDsink</sub> = 200mA			2	V
		I <sub>GDsink</sub> = 20mA			0.3	
tf	Current Fall Time			40	100	ns
tr	Current Rise Time			40	100	ns
I <sub>GDoff</sub>	I <sub>GD</sub> sink current	$Vcc = 4 V, V_{GD} = 1 V$	5	10		mA

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(1) Parameters guaranteed by design, not tested in production.

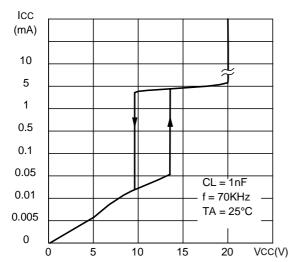
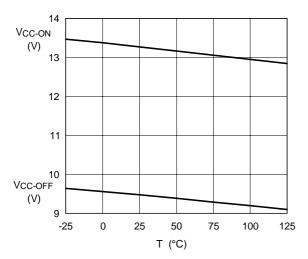


Figure 1. Supply current vs. Supply voltage







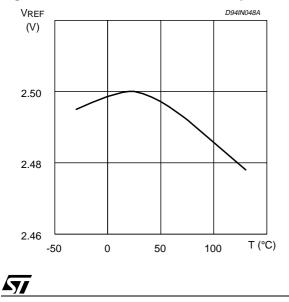
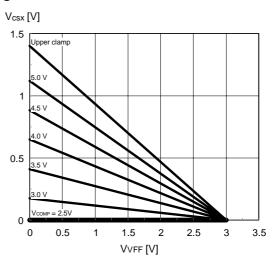
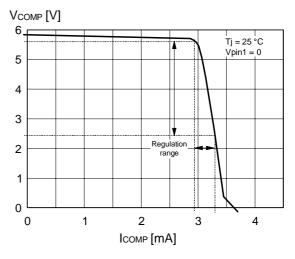
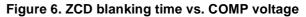


Figure 4. Line feedforward characteristics









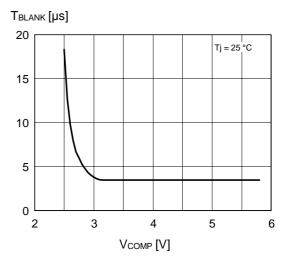
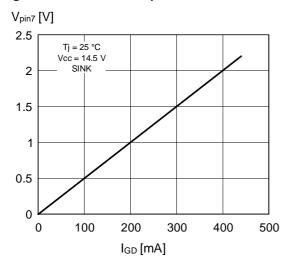
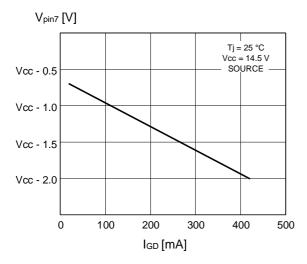


Figure 7. Gate-drive output saturation









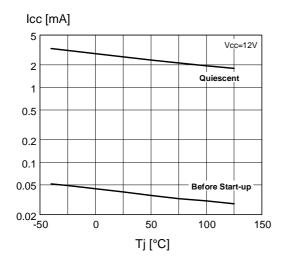




Figure 10. Zener voltage at Vcc pin vs. Tj

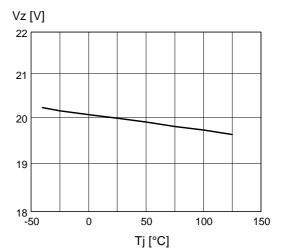
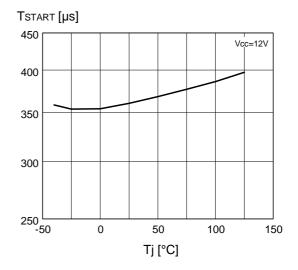


Figure 11. Start-up timer period vs. Tj



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## **APPLICATION INFORMATION**

Quasi-resonant operation in offline flyback converters lies in synchronizing MOSFET's turn-on to the transformer's demagnetization. Detecting the resulting negative-going edge of the voltage across any winding of the transformer can do this. The L6565 is provided with a dedicated pin that allows doing the job with a very simple interface, just one resistor.

Variable frequency operation - as a result of different operating conditions in terms of input voltage and output current - is inherent in such functionality. The system always works close to the boundary between DCM (Discontinuous Conduction Mode) and CCM (Continuous Conduction Mode) operation of the transformer. The operation is then identical to that of the so-called self-oscillating or Ringing Choke Converter (RCC).

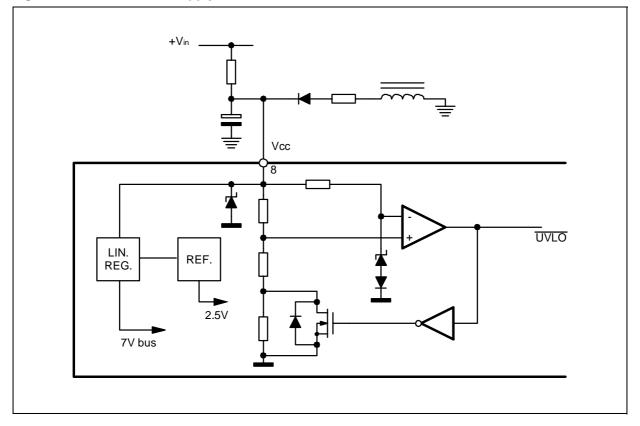
## **Detailed Device Description**

#### Internal Supply Block (see fig. 12)

A linear voltage regulator supplied by  $V_{cc}$  (pin 8) generates an internal 7V rail used for supplying the entire IC, except for the gate driver that is supplied directly from Vcc. In addition, a bandgap circuit generates a precise internal reference (2.5V±1% @ 25°C) used by the control loop to ensure a good regulation with primary feedback technique.

In figure 12 it is also shown the undervoltage lockout (UVLO) comparator with hysteresis used to enable the chip as long as the Vcc voltage is high enough to ensure a reliable operation.

#### Figure 12. L6565 internal supply block



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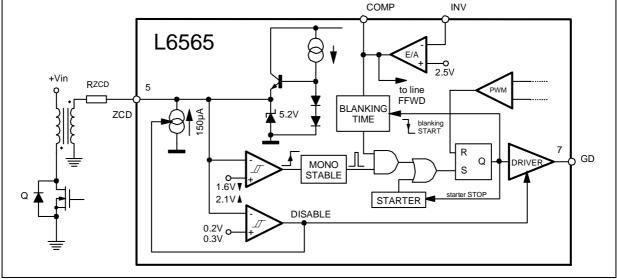
Zero Current Detection and Triggering Block (see fig. 13):

The Zero Current Detection (ZCD) block switches on the external MOSFET if a negative-going edge falling below 1.6 V is applied to the input (pin 5, ZCD). However, to ensure high noise immunity, the triggering block must be armed first: prior to falling below 1.6V, the voltage on pin 5 must experience a positive-going edge exceeding 2.1 V.

This feature is typically used to detect transformer demagnetization for QR operation, where the signal for the ZCD input is obtained from the transformer's auxiliary winding used also to supply the IC. Alternatively, this can be used to synchronize MOSFET's turn-on to the negative-going edge of an external clock signal, in case the device is not required to work in QR mode but as a standard PWM controller in a synchronized system (e.g. monitor SMPS).

The triggering block is blanked for a certain time after the MOSFET has been turned off. This has two goals: first, to prevent any negative-going edge that follows leakage inductance demagnetization from triggering the ZCD circuit erroneously; second, to realize the Frequency Foldback function (see the relevant description).





A circuit is needed that turns on the external MOSFET at start-up since no signal is coming from the ZCD pin. This is realized with an internal starter, which forces the driver to deliver a pulse to the gate of the MOSFET.

To minimize the external interface with the synchronization source (either the auxiliary winding or an external clock), the voltage at the pin is both top and bottom limited by a double clamp, as illustrated in the internal diagram of the ZCD block of figure 13. The upper clamp is typically located at 5.2 V, while the lower clamp is at one  $V_{BE}$  above ground. The interface will then be made by just one resistor that has to limit the current sourced by and sunk from the pin within the rated capability of the internal clamps.

## Disable Block (see fig. 13):

The ZCD pin is used also to activate the Disable Block. If the voltage on the pin is taken below 150 mV the device will be shut down. To do so, it is necessary to override the source capability (10 mA max.) of the internal lower clamp. While in disable, the current consumption of the IC will be reduced. To re-enable device operation, the pull-down on the pin must be released.

## Frequency Foldback Block (see fig. 13):

To prevent the switching frequency from reaching too high values, which is a typical drawback of QR operation,

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the L6565 puts a limit on the minimum OFF-time of the switch. This is done by blanking the triggering block of the ZCD circuit as mentioned before. The duration of the blanking time (3.5µs min.) is a function of the error amplifier output VCOMP, as shown in the diagram of figure 6.

If the load current and the input voltage are such that the switch OFF-time falls below the minimum blanking time of 3.5µs, the system will enter the "Frequency Foldback" mode, a sort of "ringing cycle skipping" illustrated schematically in figure 14.

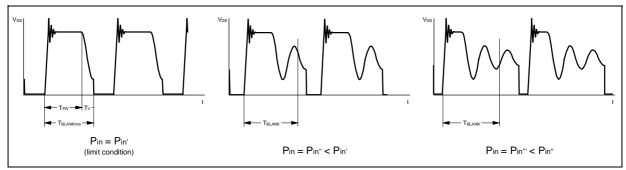
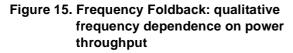
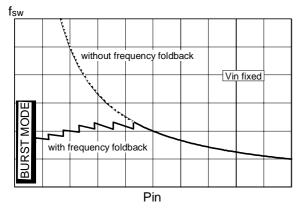


Figure 14. Frequency foldback: ringing cycle skipping as the load is progressively reduced

In this mode, uneven switching cycles may be observed under some line/load conditions, due to the fact that the OFF-time of the MOSFET is allowed to change with discrete steps (2·Tv), while the OFF-time needed for cycle-by-cycle energy balance may fall in between. Thus one or more longer switching cycles will be compensated by one or more shorter ones and vice versa. However, this mechanism is absolutely normal and there is no appreciable effect on the performance of the converter or on its output voltage.





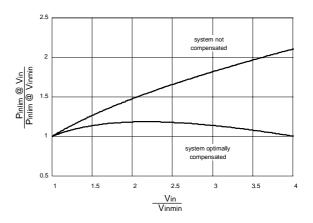
Further load reductions involve lower values for VCOMP, which increases the blanking time. Therefore, more and more ringing cycles will be skipped. When the load is low enough, so many ringing cycles need to be skipped that their amplitude becomes very small and they can no longer trigger the ZCD circuit. In that case the internal starter of the IC will be activated, resulting in burst-mode operation: a series of few switching cycles spaced out by long periods where the MOSFET is in OFF state.

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Voltage Feedforward block (see fig. 17b):

The power that QR flyback converters with a fixed overcurrent setpoint (like fixed-frequency systems) are able to deliver changes with the input voltage considerably. With wide-range mains, at maximum line it can be more than twice the value at minimum line, as shown by the upper curve in the diagram of figure 16. The L6565 has the Line Feedforward function available to solve this issue.

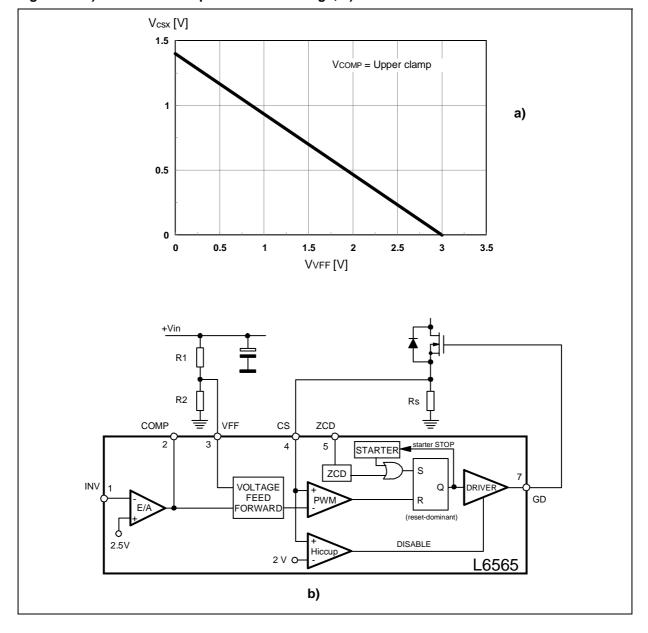
#### Figure 16. Typical power capability change vs. input voltage in ZVS QR flyback converters



It acts on the clamp level of the control voltage  $V_{CSX}$ , that is on the overcurrent setpoint, so that it is a function of the converter's input voltage sensed through a decicated pin (#3, VFF): the higher the input voltage, the lower the setpoint. This is illustrated in the diagram of figure 17a that shows the relationship between the voltage at the pin VFF and  $V_{CSX}$  (with the error amplifier saturated high in the attempt of keeping output voltage regulation). The schematic in figure 17b shows also how the function is included in the control loop. With a proper selection of the external divider R1-R2 it is possible to achieve the optimum compensation described by the lower curve in the diagram of figure 16.

In applications where this function is not wanted, e.g. because of a narrow input voltage range, the VFF pin can be simply grounded, thus saving the resistor divider. The overcurrent setpoint will be then fixed at the maximum value of about 1.4V (1.5V max.).

Line Feedforward is also beneficial to other characteristics of quasi-resonant converters: it improves their input ripple rejection ability and limits the variation of the power stage's small-signal gain versus the line voltage.



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Figure 17. a) Overcurrent setpoint vs. VFF voltage; b) Line Feedforward function block

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#### Error Amplifier Block (see fig. 17b):

The Error Amplifier (E/A) inverting input is used in primary feedback technique to compare a partition of the voltage generated by the auxiliary winding with the internal reference, to achieve converter's output voltage regulation (see "Application Ideas", fig. 24). With secondary feedback (typically using a TL431 at the secondary side and an optocoupler to transfer output voltage information to the primary side through the isolation barrier) the E/A can be used as an inverting level-shifter to achieve negative feedback and shape the loop gain (see "Application Ideas", fig. 23).

The E/A output is used typically for control loop compensation, realized with an RC network connected to the inverting input. With other secondary feedback techniques, the output is driven directly by an emitter-grounded optocoupler to modulate the duty cycle (the inverting input will be grounded in that case - see figure 23 in "Application Ideas").

#### Current Comparator, PWM Latch and Hiccup-mode OCP (see fig. 17b):

The current comparator senses the voltage across the current sense resistor (Rs) and, by comparing it with the programming signal delivered by the feedforward block, determines the exact time when the external MOSFET is to be switched off. The PWM latch avoids spurious switching of the MOSFET, which might result from the noise generated ("double-pulse suppression").

A comparator senses the voltage on the current sense input and disables the gate driver if the voltage at the pin exceeds 2 V. Such anomalous condition is typically generated by a short circuit on the secondary rectifier or on the secondary winding. To re-enable the driver, first the IC must be turned off and then can be restarted, that is the Vcc voltage must fall below the UVLO threshold.

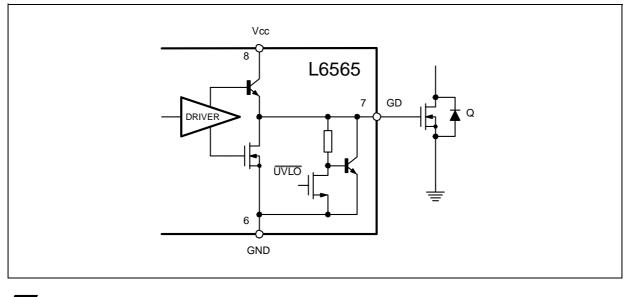
When the gate driver is disabled the quiescent current of the IC is unchanged and, since no energy is coming from the self-supply circuit, the Vcc capacitor will be discharged below the UVLO threshold after some time. Then the device will initiate a new start-up cycle. In case of failure of the secondary diode the resulting behavior will be a low-frequency intermittent operation (Hiccup-mode operation), with very low stress on the power circuit.

#### Gate Driver (see fig. 18):

A totem pole buffer, with 400mA source and sink capability, drives the external MOSFET. It is made up of a high-side NPN Darlington and a low-side MOSFET. In this way there is no need of an external diode clamp to prevent the voltage at the gate drive output (pin 7, GD) from being pulled too negative.

An internal pull-down circuit holds the output low when the device is in UVLO conditions, to ensure that the external MOSFET cannot be turned on accidentally (e.g. at power-on).

#### Figure 18. Gate driver with UVLO pull-down



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## **TYPICAL APPLICATIONS**

#### Figure 19. 50W Wide Range Mains SMPS for 14" TV

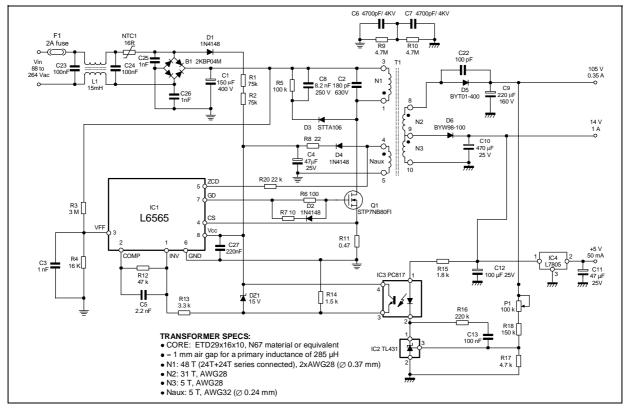
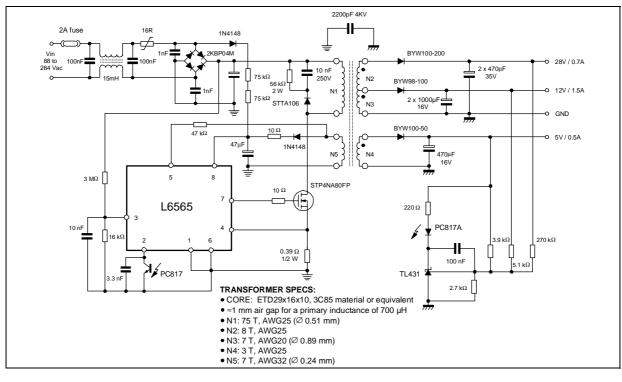


Figure 20. 40W Wide Range Mains SMPS for inkjet printer

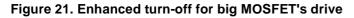


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# **APPLICATION IDEAS**

Here follows a series of ideas/suggestions aimed at either improving performance or solving common application issues of L6565-based power supplies.



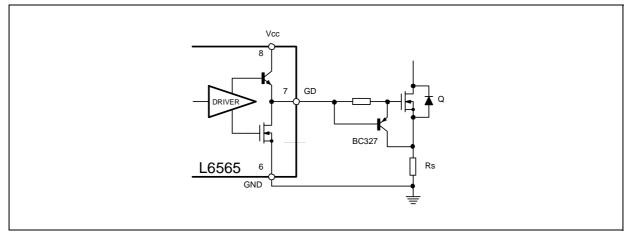
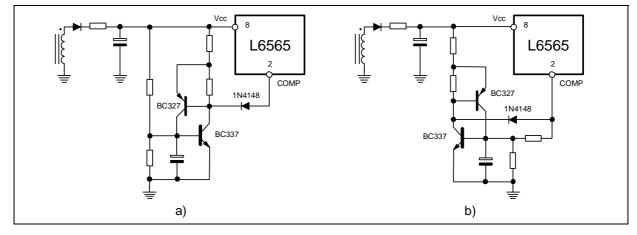


Figure 22. Latched shutdown on: a) feedback disconnection; b) overload or short circuit





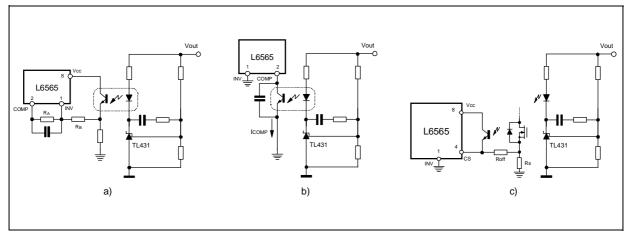
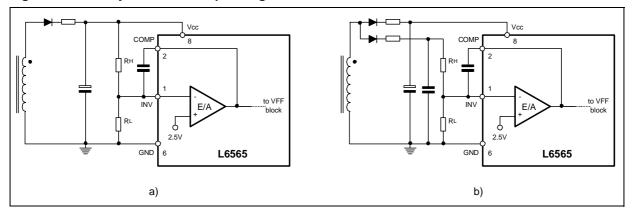
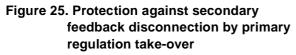
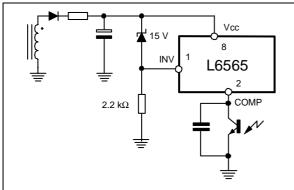


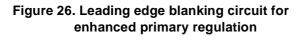


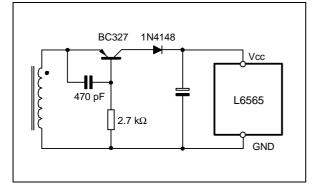
Figure 24. Primary Feedback loop configurations

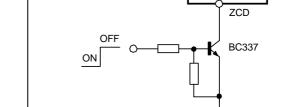






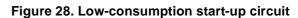


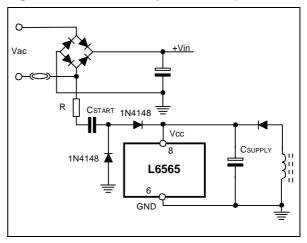




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Figure 27. Remote ON/OFF control





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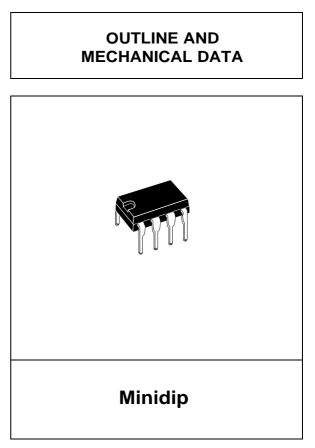
## **RELATED DOCUMENTATION**

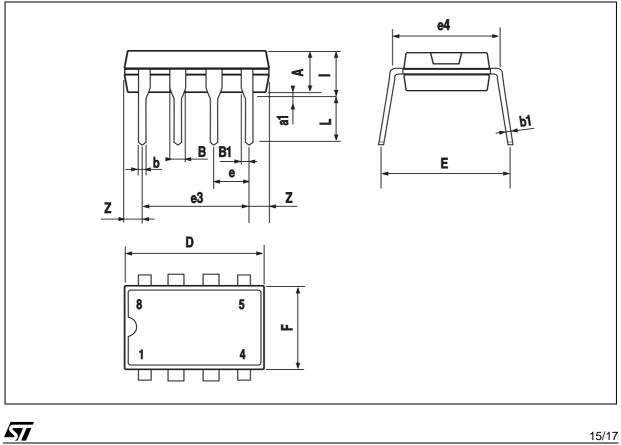
- [1] "L6565, QUASI-RESONANT CONTROLLER" (AN1326)
- [2] "25W QUASI-RESONANT FLYBACK CONVERTER FOR SET-TOP BOX APPLICATIONS USING THE L6565" (AN1376)
- [3] "EVAL6565N, 30W AC-DC ADAPTER WITH THE L6565 QUASI-RESONANT PWM CONTROLLER" (AN1439).

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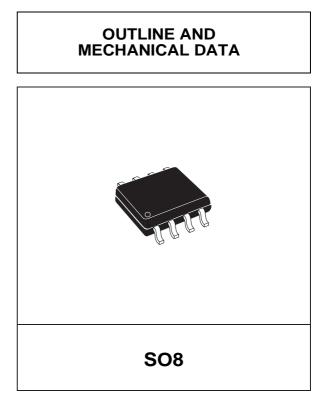
DIM.	mm			inch			
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	
А		3.32			0.131		
a1	0.51			0.020			
В	1.15		1.65	0.045		0.065	
b	0.356		0.55	0.014		0.022	
b1	0.204		0.304	0.008		0.012	
D			10.92			0.430	
Е	7.95		9.75	0.313		0.384	
е		2.54			0.100		
e3		7.62			0.300		
e4		7.62			0.300		
F			6.6			0.260	
I			5.08			0.200	
L	3.18		3.81	0.125		0.150	
Z			1.52			0.060	



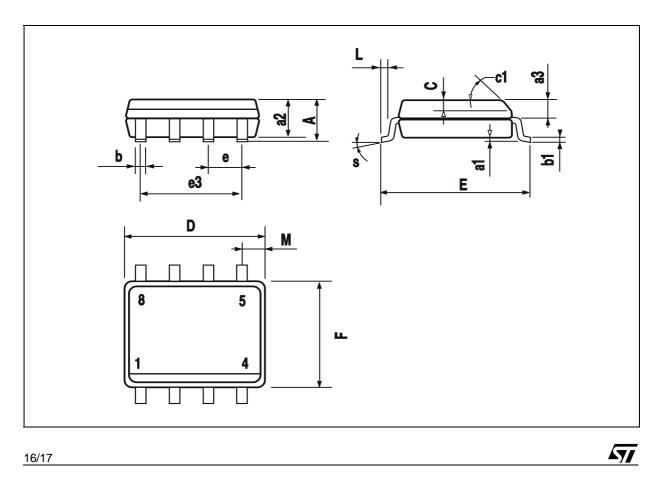


# L6565

DIM.	mm			inch			
Dilvi.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	
А			1.75			0.069	
a1	0.1		0.25	0.004		0.010	
a2			1.65			0.065	
a3	0.65		0.85	0.026		0.033	
b	0.35		0.48	0.014		0.019	
b1	0.19		0.25	0.007		0.010	
С	0.25		0.5	0.010		0.020	
c1			45° (	(typ.)			
D (1)	4.8		5.0	0.189		0.197	
Е	5.8		6.2	0.228		0.244	
е		1.27			0.050		
e3		3.81			0.150		
F (1)	3.8		4.0	0.15		0.157	
L	0.4		1.27	0.016		0.050	
М			0.6			0.024	
S	8° (max.)						



(1) D and F do not include mold flash or protrusions. Mold flash or potrusions shall not exceed 0.15mm (.006inch).



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